

4.5Ω Low Voltage SPDT Analog Switch

1 FEATURES

- **High Bandwidth: 340MHz**
- **High Speed:**
 - t_{pd} : 2ns at $V_{CC}=2.3V$ to 5.5V Typically
 - t_{on} : 4ns at $V_{CC}=5V$ Typically
 - t_{off} : 3.5ns at $V_{CC}=5V$ Typically
- **Supply Range: 1.65V to 5.5V**
- **Low ON-State Resistance: 4.5Ω(TYP)**
- **Break-Before-Make Switching**
- **Rail-to-Rail Operation**
- **Extended Industrial Temperature Range: -40°C to 125°C**
- **ESD Protection Exceeds JESD 22**
 - 3000-V Human-Body Model
 - 1000-V Charged-Device Model (JS-002)
- **Micro SIZE PACKAGES: SC70-6, SOT23-6, XDFN1X1-6**

2 APPLICATIONS

- **Wearable Devices**
- **Battery-Operated Equipment**
- **Signal Gating, Chopping, Modulation or Demodulation (Modem)**
- **Portable Computing**
- **Cell Phones**

3 DESCRIPTIONS

The RS2057A is a single-pole double-throw (SPDT) analog switch that is designed to operate from 1.65 V to 5.5 V.

The RS2057A device can handle both analog and digital signals. It features high-bandwidth (340MHz) and low on-resistance (4.5Ω TYP).

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-to-analog conversion systems.

Device Information (1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
RS2057A	SOT23-6	2.92mm×1.60mm
	SC70-6	2.10mm×1.25mm
	XDFN1X1-6	1.00mm×1.00mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

4 BLOCK DIAGRAM

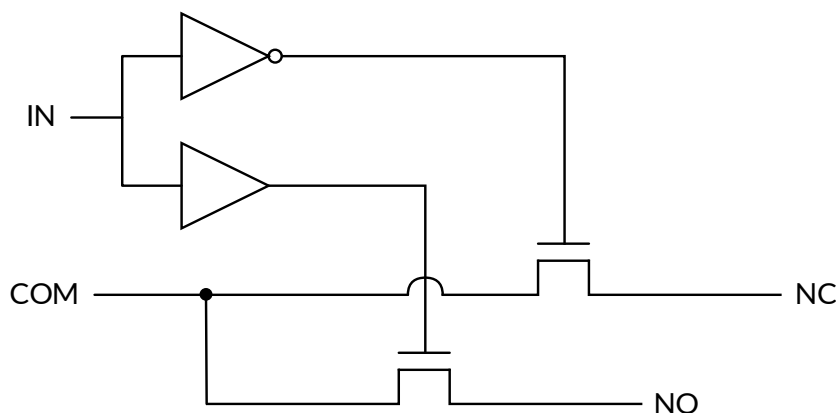


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5 REVISION HISTORY

Note: Page numbers for previous revisions may differ from page numbers in the current version.

VERSION	Change Date	Change Item
A.0	2024/09/05	Preliminary version completed
A.1	2024/11/05	Initial version completed
A.2	2025/08/19	1. Add XDFN1X1-6 package 2. Update Typical Characteristics Figure 1 to Figure 4

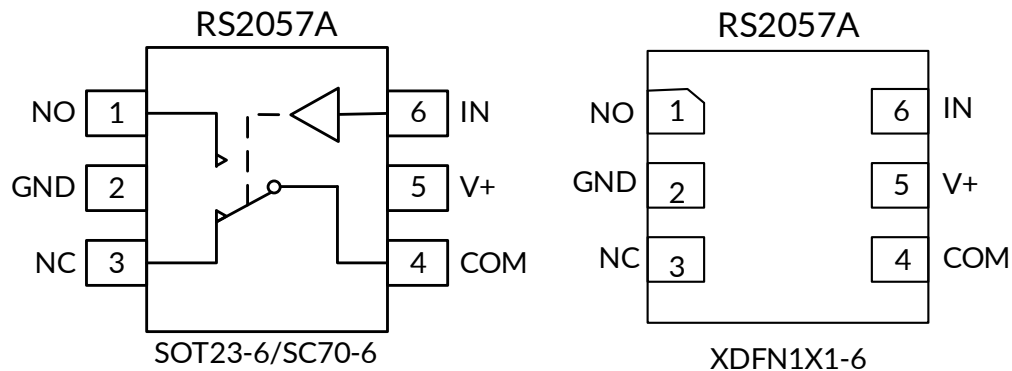
6 PACKAGE/ORDERING INFORMATION ⁽¹⁾

PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING ⁽²⁾	MSL ⁽³⁾	PACKAGE OPTION
RS2057A	RS2057AXC6	-40°C ~125°C	SC70-6 ⁽⁴⁾	2057A	MSL3	Tape and Reel, 3000
	RS2057AXH	-40°C ~125°C	SOT23-6	2057A	MSL3	Tape and Reel, 3000
	RS2057AXUTDN6	-40°C ~125°C	XDFN1X1-6	7A ⁽⁵⁾	MSL3	Tape and Reel, 5000

NOTE:

- (1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.
- (2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.
- (3) Runic classify the MSL level with using the common preconditioning setting in our assembly factory conforming to the JEDEC industrial standard J-STD-20F, Please align with Runic if your end application is quite critical to the preconditioning setting or if you have special requirement.
- (4) Equivalent to SOT363.
- (5) 7A: Identification Code.

7 PIN CONFIGURATION



NOTE: NO, NC and COM terminals may be an input or output

PIN DESCRIPTION

NAME	PIN	FUNCTION
	SOT23-6/SC70-6/XDFN1X1-6	
NO	1	Normally-Open Terminal
GND	2	Ground
NC	3	Normally-Closed Terminal
COM	4	Common Terminal
V+	5	Power Supply
IN	6	Digital Control Pin

FUNCTION TABLE

LOGIC	NO	NC
0	OFF	ON
1	ON	OFF

8 SPECIFICATIONS

8.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) ⁽¹⁾

SYMBOL	PARAMETER	MIN	MAX	UNIT
V ₊	Supply Voltage	-0.5	6	V
V _{IN}	Input Voltage	-0.5	6	
	Analog, Digital Voltage Range ⁽²⁾	-0.5	(V ₊)+0.5	
	Continuous Current NO, NC, or COM	-50	50	mA
I ₊	Supply current		100	
I _{GND}	Ground current	-100		
θ _{JA}	Package thermal impedance ⁽³⁾	SOT23-6	235	°C/W
		SC70-6	270	
		XDFN1X1-6	440	
T _J	Junction Temperature ⁽⁴⁾		150	°C
T _{stg}	Storage temperature	-65	150	

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 100mA or less.

(3) The package thermal impedance is calculated in accordance with JESD-51.

(4) The maximum power dissipation is a function of T_{J(MAX)}, R_{θJA}, and T_A. The maximum allowable power dissipation at any ambient temperature is P_D = (T_{J(MAX)} - T_A) / R_{θJA}. All numbers apply for packages soldered directly onto a PCB.

8.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

		VALUE	UNIT
V _(ESD) Electrostatic discharge	Human-Body Model (HBM), per ANSI/ESDA/JEDEC JS001-2023	±3000	V
	Charged-Device Model (CDM), per ANSI/ESDA/JEDEC JS-002-2022	±1000	V



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

8.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

SYMBOL	PARAMETER	MIN	MAX	UNIT
V ₊	Supply Voltage	1.65	5.5	V
T _A	Operating temperature	-40	125	°C

8.4 Electrical Characteristics

$V_+ = 5.0\text{ V}$, $T_A = -40^\circ\text{C}$ to 125°C (unless otherwise noted)

PARAMETER	SYMBOL	CONDITIONS	V_+	T_A	MIN ⁽²⁾	TYP ⁽³⁾	MAX ⁽²⁾	UNIT
ANALOG SWITCH								
Analog Signal Range	V_{NO}, V_{NC}, V_{COM}			FULL	0		V_+	V
On-Resistance	R_{ON}	V_{NO} or $V_{NC} = 0\text{V}$ to V_+ , $I_{COM} = -10\text{mA}$, Switch ON, See Figure 10	1.65V	+25°C		60	65	Ω
				FULL			70	Ω
			1.8V	+25°C		42	50	Ω
				FULL			60	Ω
			2.7V	+25°C		11	15	Ω
				FULL			18	Ω
			3.3V	+25°C		7.5	10	Ω
				FULL			10.5	Ω
			5V	+25°C		4.5	7.5	Ω
				FULL			8.5	Ω
On-Resistance Match Between Channels	ΔR_{ON}	V_{NO} or $V_{NC} = 0\text{V}$ to V_+ , $I_{COM} = -10\text{mA}$, Switch ON, See Figure 10	1.65V	+25°C		1	1.2	Ω
				FULL			1.5	Ω
			1.8V	+25°C		0.8	1	Ω
				FULL			1.3	Ω
			2.7V	+25°C		0.25	0.35	Ω
				FULL			0.5	Ω
			3.3V	+25°C		0.15	0.3	Ω
				FULL			0.4	Ω
			5V	+25°C		0.15	0.3	Ω
				FULL			0.4	Ω
On-Resistance Flatness	$R_{FLAT(ON)}$	V_{NO} or $V_{NC} = 0\text{V}$ to V_+ , $I_{COM} = -10\text{mA}$, Switch ON, See Figure 10	1.65V	+25°C		51	53	Ω
				FULL			55	Ω
			1.8V	+25°C		38	46	Ω
				FULL			57	Ω
			2.7V	+25°C		6	7	Ω
				FULL			8	Ω
			3.3V	+25°C		3	4	Ω
				FULL			4.3	Ω
			5V	+25°C		2	3	Ω
				FULL			3.3	Ω
NC, NO OFF Leakage Current	$I_{NC(OFF)}, I_{NO(OFF)}$	V_{NO} or $V_{NC} = 0.3\text{V}$, $V_+/2$ $V_{COM} = V_+/2$, 0.3V See Figure 11	1.65V to 5.5V	FULL			1	μA
NC, NO, COM ON Leakage Current	$I_{NC(ON)}, I_{NO(ON)}, I_{COM(ON)}$	V_{NO} or $V_{NC} = 0.3\text{V}$, Open $V_{COM} = \text{Open}$, 0.3V See Figure 12	1.65V to 5.5V	FULL			1	μA

DIGITAL CONTROL INPUTS ⁽¹⁾								
Input High Voltage	V_{INH}		1.65V to 1.95V	FULL	$0.75V_{CC}$			V
			2.3V to 5.5V	FULL	$0.7 V_{CC}$			V
Input Low Voltage	V_{INL}		1.65V to 1.95V	FULL			$0.25V_{CC}$	V
			2.3V to 5.5V	FULL			$0.3V_{CC}$	V
Input Leakage Current	I_{IN}	$V_{IN} = V_+ \text{ or } 0$	1.65V to 5.5V	FULL			1	μA

(1) All unused digital inputs of the device must be held at VIO or GND to ensure proper device operation.

(2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.

(3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.

Electrical Characteristics (continued)

V₊ = 5.0 V, T_A = -40°C to 125°C (unless otherwise noted)

PARAMETER	SYMBOL	CONDITIONS	V ₊	T _A	MIN	TYP	MAX	UNIT
DYNAMIC CHARACTERISTICS								
Propagation delay	t _{pd}	t _{PLH} & t _{PHL} , R _L =500Ω, C _L =50pF, See Figure 15	1.65V to 1.95V	FULL		6	9	ns
			2.3V to 5.5V	FULL		2	2.4	
Turn-On Time	t _{ON}	t _{PZH} & t _{PZL} , R _L =500Ω, C _L =50pF, See Figure 16	1.65V	+25°C		14.5	17	ns
				FULL	6		28	
			1.8V	+25°C		12.5	13	
				FULL	5		20	
			2.7V	+25°C		7	8	
				FULL	2.5		12	
			3.3V	+25°C		5.5	6.5	
				FULL	2		10	
			5V	+25°C		4	5	
				FULL	1.5		7.5	
Turn-Off Time	t _{OFF}	t _{PLZ} & t _{PHZ} , R _L =500Ω, C _L =50pF, See Figure 16	1.65V	+25°C		10	13	ns
				FULL	5		21	
			1.8V	+25°C		8.5	12	
				FULL	4		18	
			2.7V	+25°C		5	7.5	
				FULL	2		12	
			3.3V	+25°C		4	6	
				FULL	1.5		9	
			5V	+25°C		3.5	4	
				FULL	1.5		6	
Break-Before-Make Time Delay	t _{BBM}	R _L =50Ω, C _L =50pF, See Figure 17	1.65V to 1.95V	FULL		9		ns
			2.3V to 5.5V	FULL		6		
Off Isolation	O _{ISO}	R _L = 50Ω, Switch OFF, See Figure 19		+25°C		-58		dB
				+25°C		-75		dB
Cross talk	X _{TALK}	R _L = 50Ω, Switch OFF, See Figure 20		+25°C		-59		dB
				+25°C		-76		dB
-3dB Bandwidth	BW	Switch ON, R _L = 50Ω, See Figure 18	1.65V to 1.95V	+25°C		340		MHz
			2.3V to 5.5V	+25°C		340		MHz
Charge injection	Q _{INJ}	C _L = 0.1nF, See Figure 21	1.65V	+25°C		3.3		pC
			1.8V	+25°C		3.5		pC
			2.7V	+25°C		4		pC
			3.3V	+25°C		5		pC
			5V	+25°C		8		pC

NC, NO OFF Capacitance	$C_{NC(OFF)}$, $C_{NO(OFF)}$	V_{NC} or $V_{NO}=V+/2$ or GND, Switch OFF, See Figure 13		+25°C		9		pF
NC, NO, COM ON Capacitance	$C_{NC(ON)}$, $C_{NO(ON)}$, $C_{COM(ON)}$	V_{NC} or $V_{NO}=V+/2$ or GND, Switch ON, See Figure 13		+25°C		16		pF
POWER REQUIREMENTS								
Power Supply Range	V_+			FULL	1.65		5.5	V
Power Supply Current	I_+	$V_{IN} = \text{GND or } V_+$	5.5V	FULL			1	μA

8.5 Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

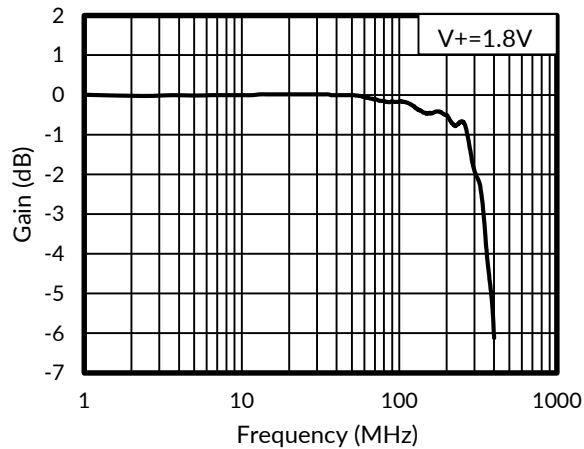


Figure 1. Bandwidth vs Frequency

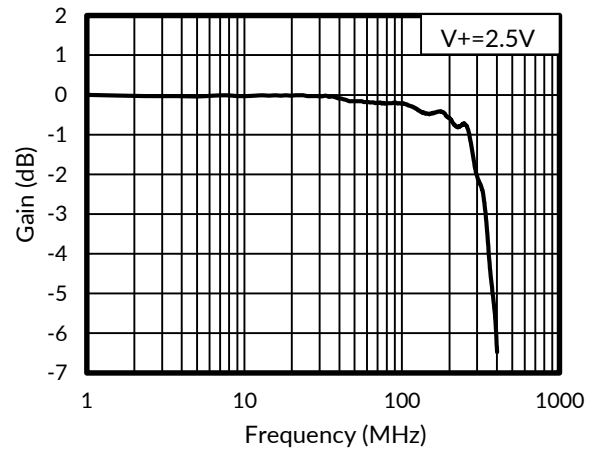


Figure 2. Bandwidth vs Frequency

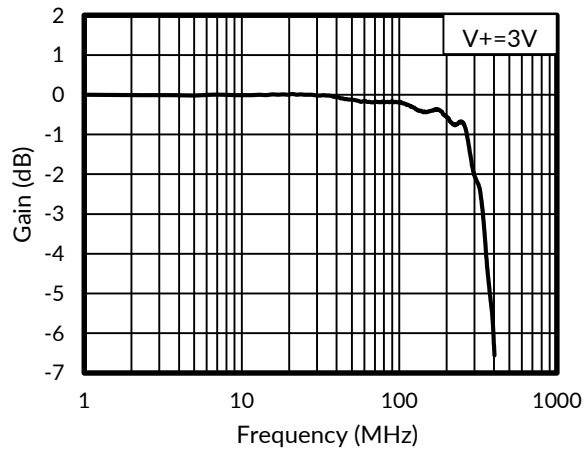


Figure 3. Bandwidth vs Frequency

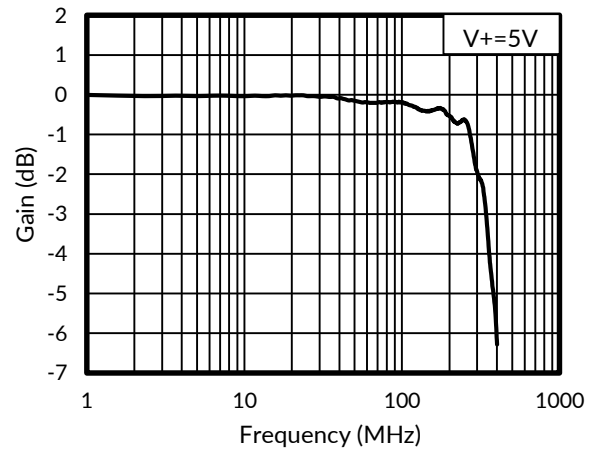


Figure 4. Bandwidth vs Frequency

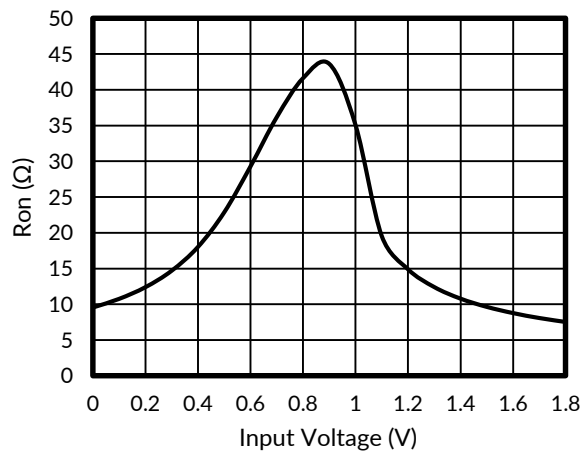


Figure 5. Typical Ron as a Function of Input Voltage ($V_+ = 1.8\text{ V}$)

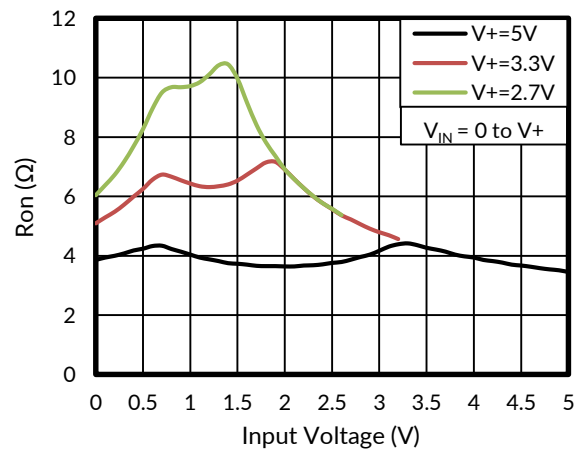


Figure 6. Typical Ron as a Function of Input Voltage

Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

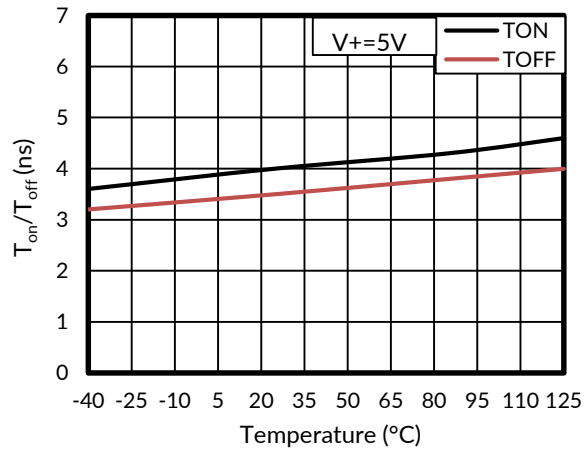


Figure 7. T_{on} and T_{off} vs Temperature

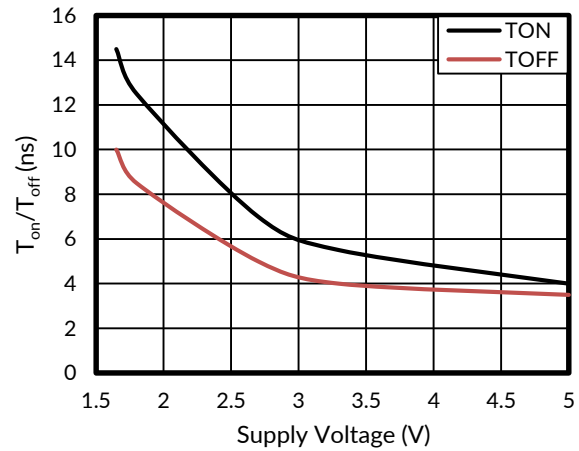


Figure 8. T_{on} and T_{off} vs Supply Voltage

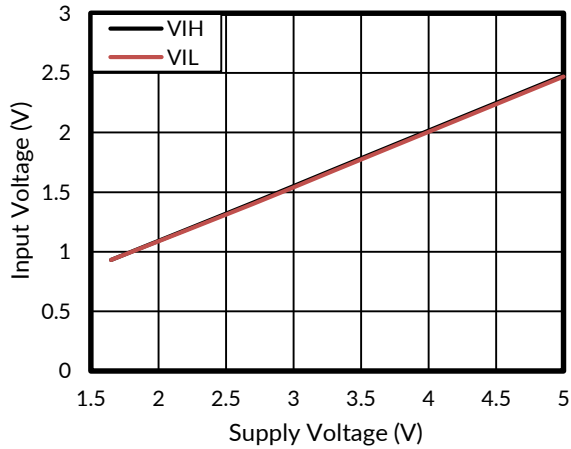


Figure 9. Logic-Level Threshold vs V_{+}

9 PARAMETER MEASUREMENT INFORMATION

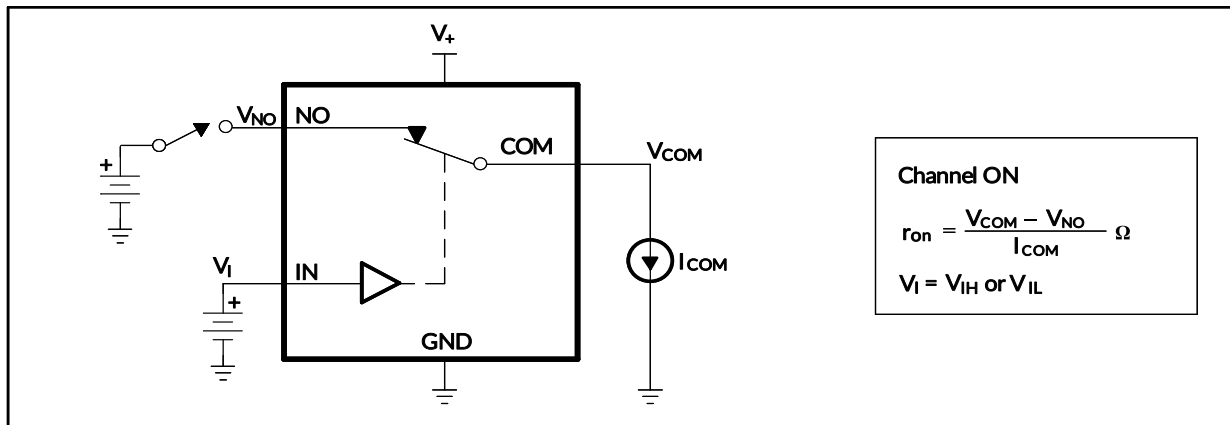


Figure 10. ON-State Resistance (R_{on})

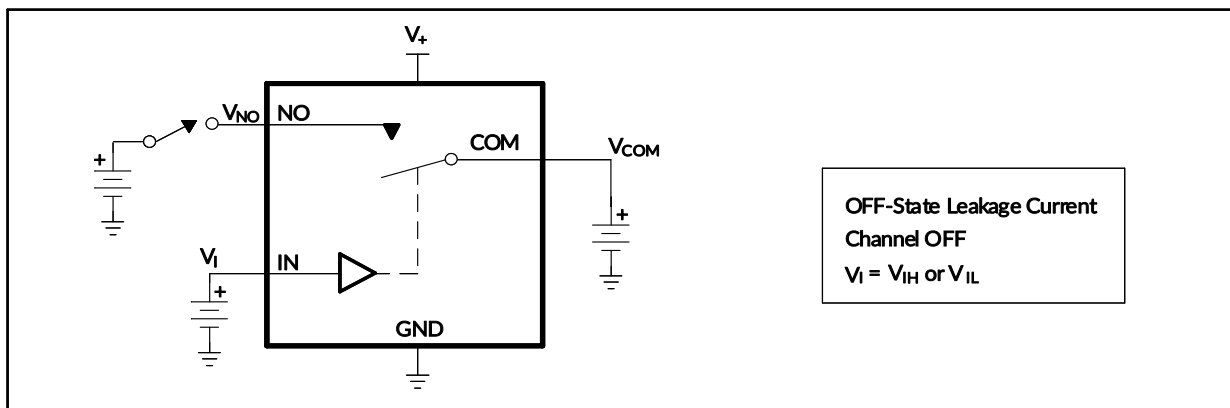


Figure 11. OFF-State Leakage Current ($I_{com(off)}$, $I_{no(off)}$)

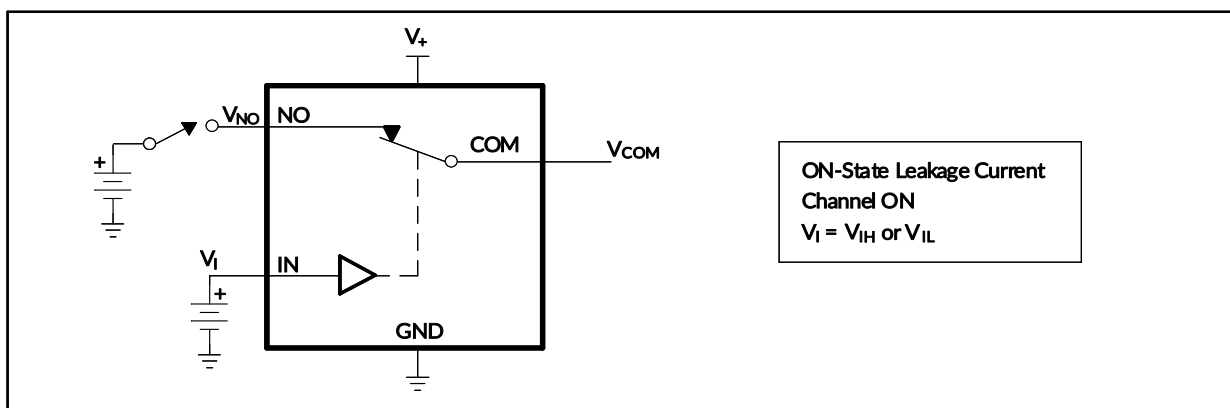


Figure 12. ON-State Leakage Current ($I_{com(on)}$, $I_{no(on)}$)

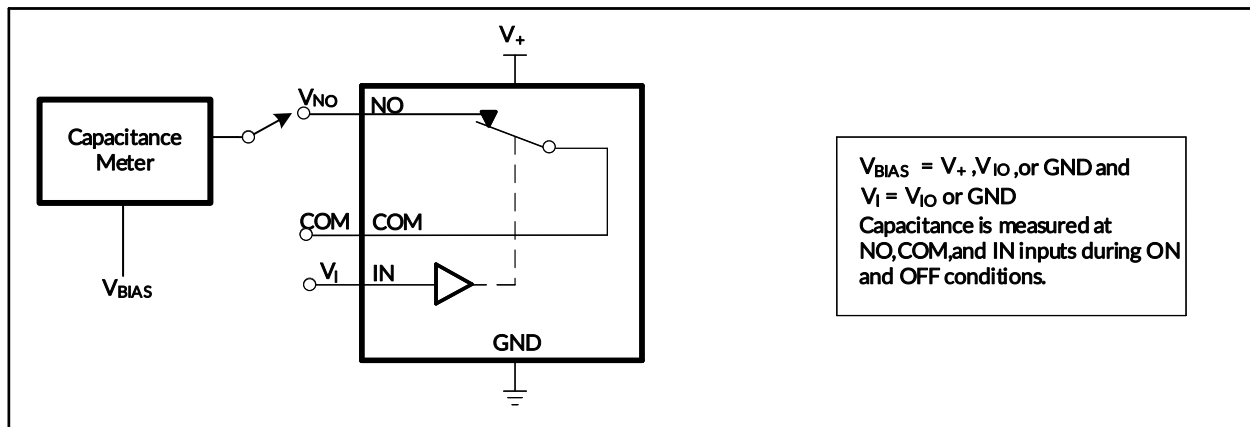


Figure 13. Capacitance (C_I , $C_{COM(OFF)}$, $C_{COM(ON)}$, $C_{NO(OFF)}$, $C_{NO(ON)}$)

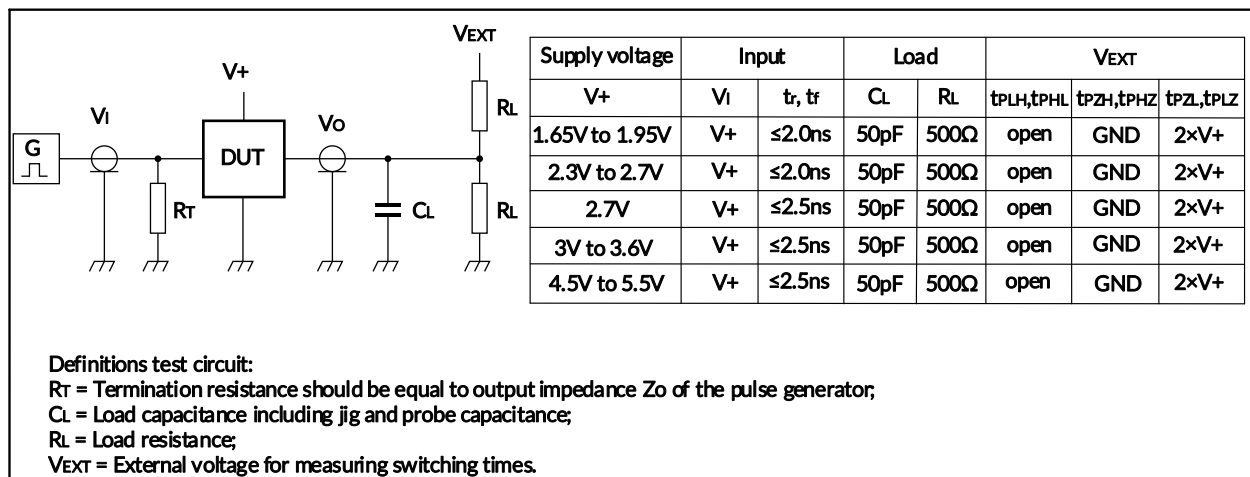


Figure 14. Test circuit for measuring switching times

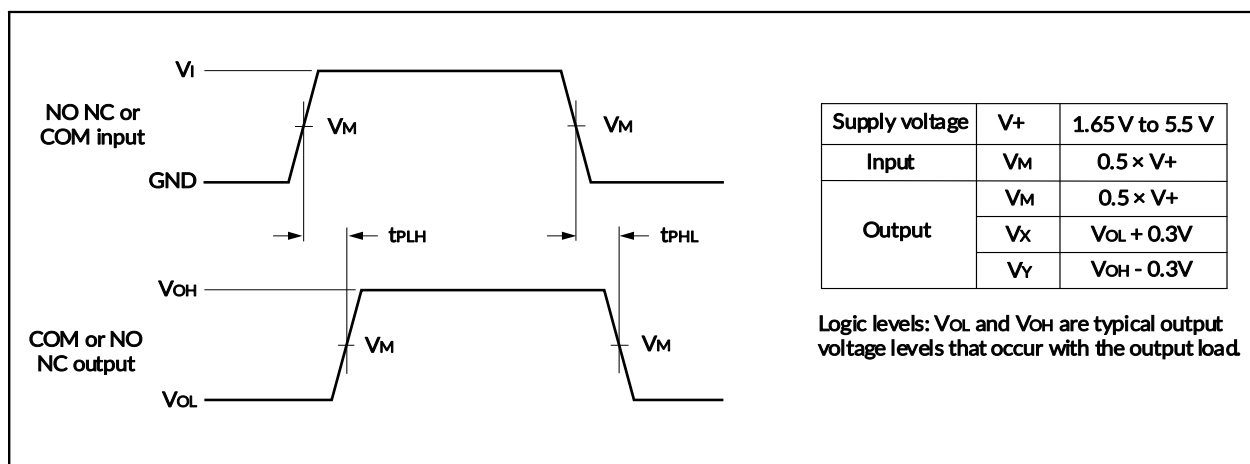


Figure 15. Propagation delay (t_{pd})

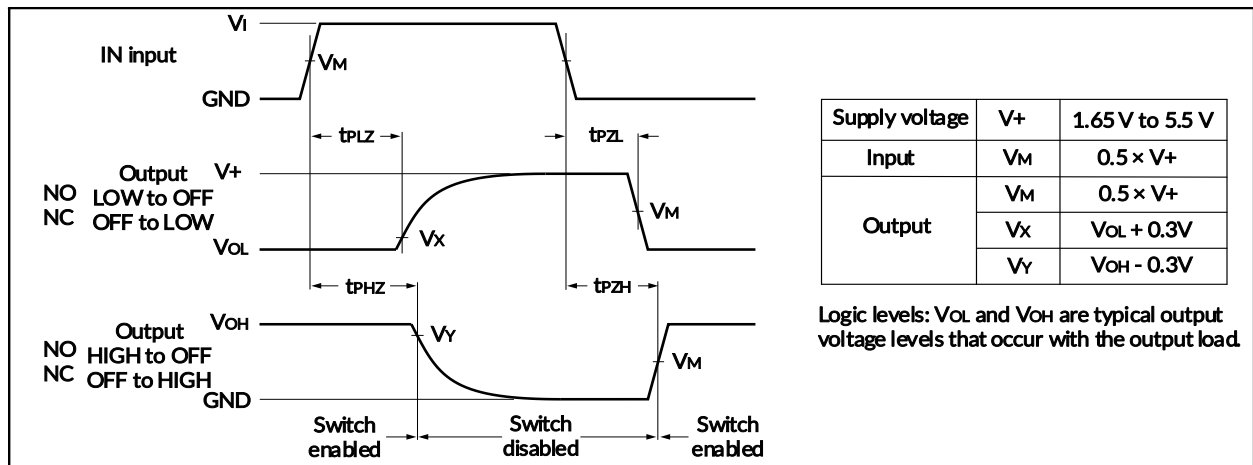


Figure 16. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})

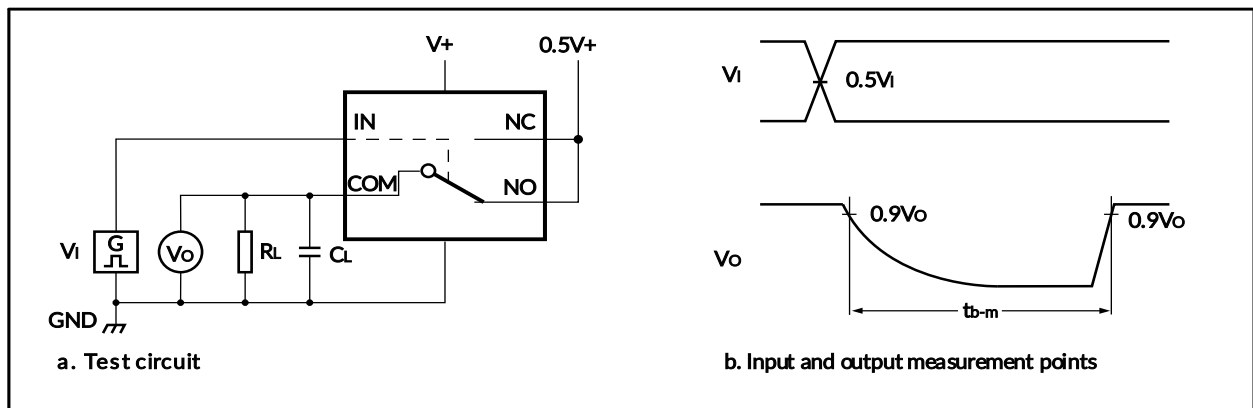


Figure 17. Break-Before-Make Time (t_{BBM})

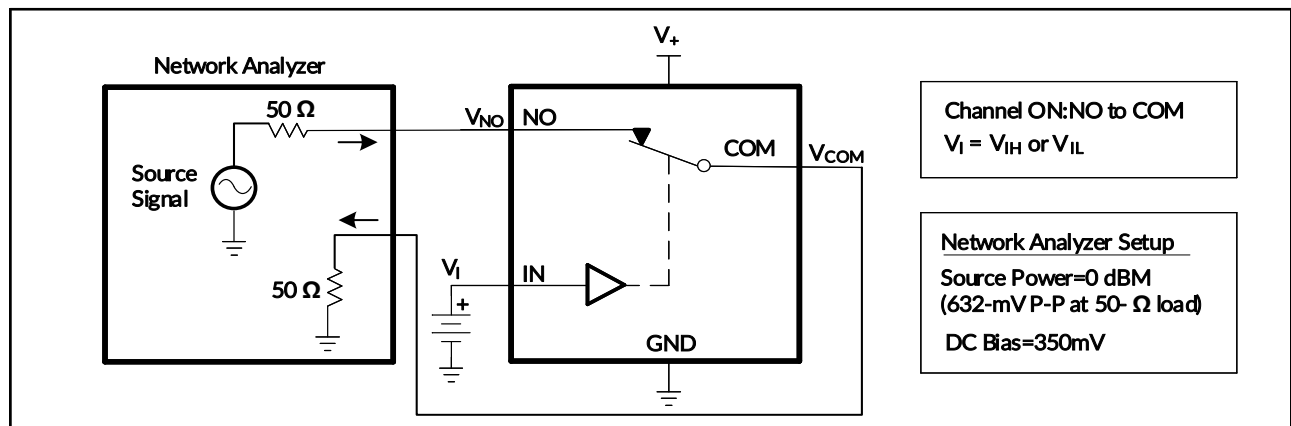
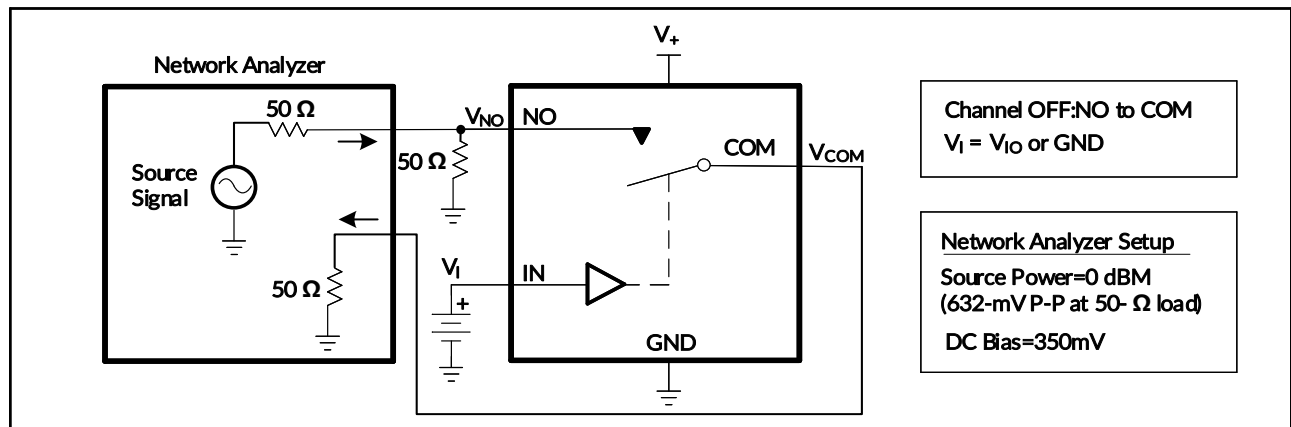
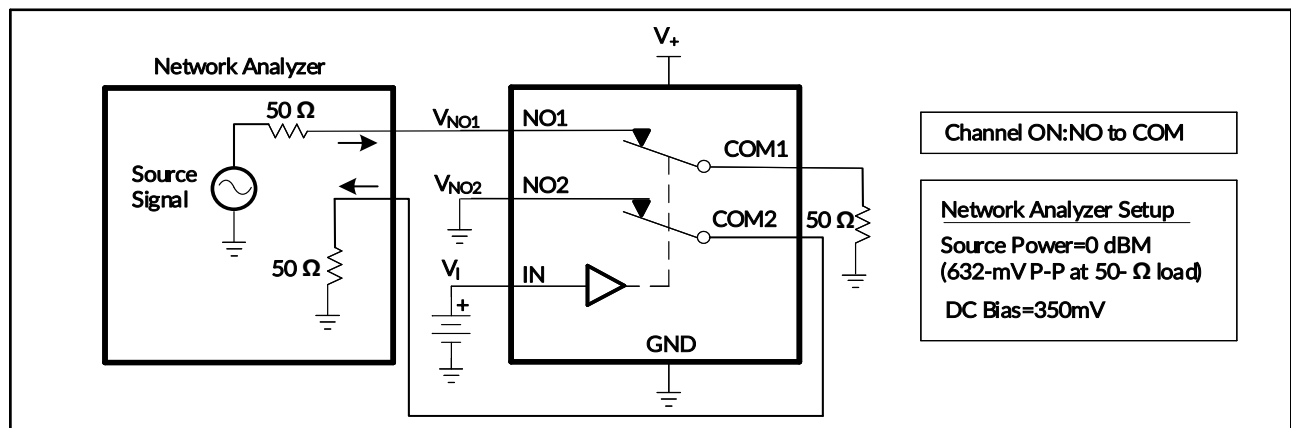
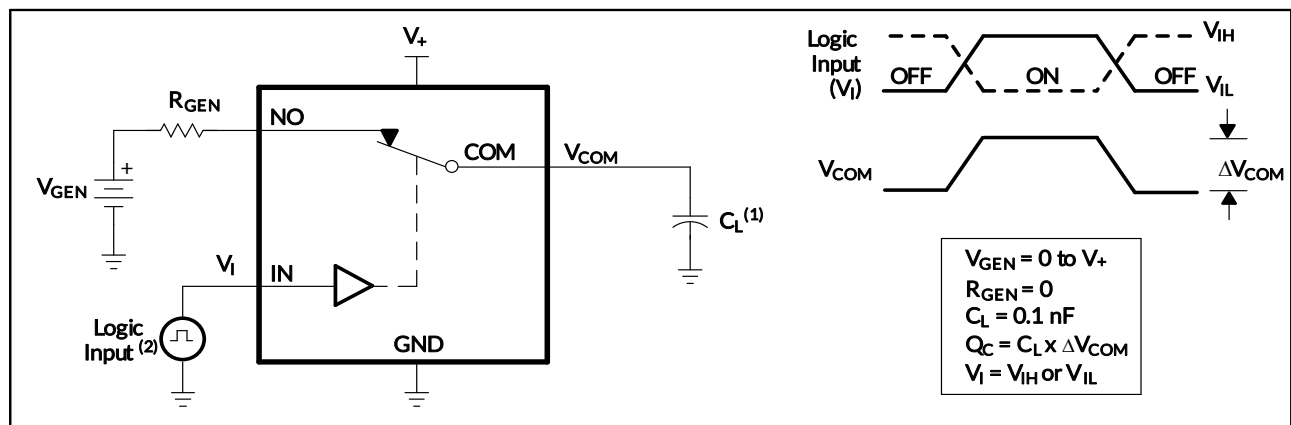


Figure 18. Bandwidth (BW)


Figure 19. OFF Isolation (O_{Iso})

Figure 20. Crosstalk (X_{TALK})

Figure 21. Charge Injection (Q_C)

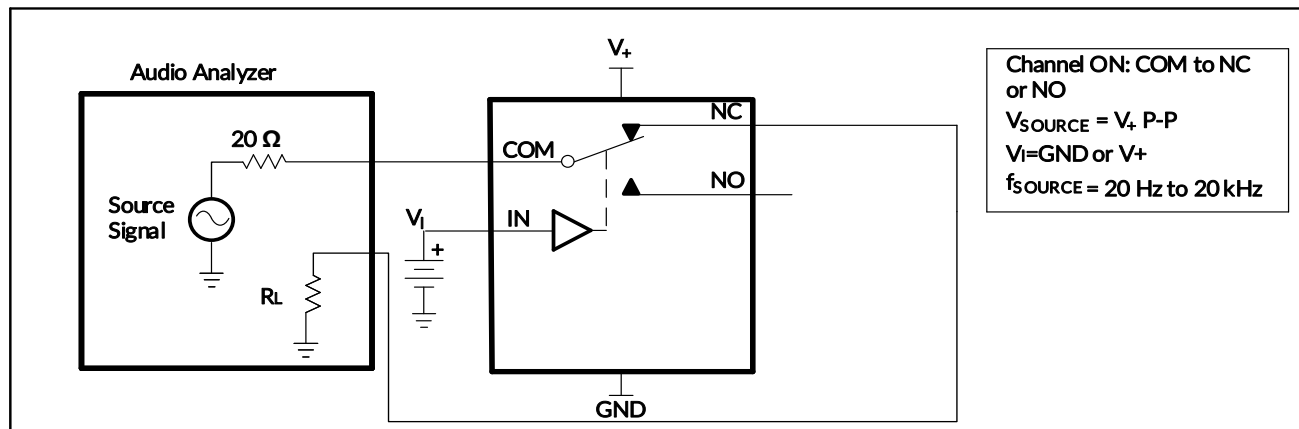


Figure 22. Total Harmonic Distortion (THD)

10 APPLICATION AND IMPLEMENTATION

Information in the following applications sections is not part of the RUNIC component specification, and RUNIC does not warrant its accuracy or completeness. RUNIC's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

10.1 Application Information

The RS2057A can be used in a variety of customer systems. The RS2057A can be used anywhere multiple analog or digital signals must be selected to pass across a single line.

10.2 Typical Application

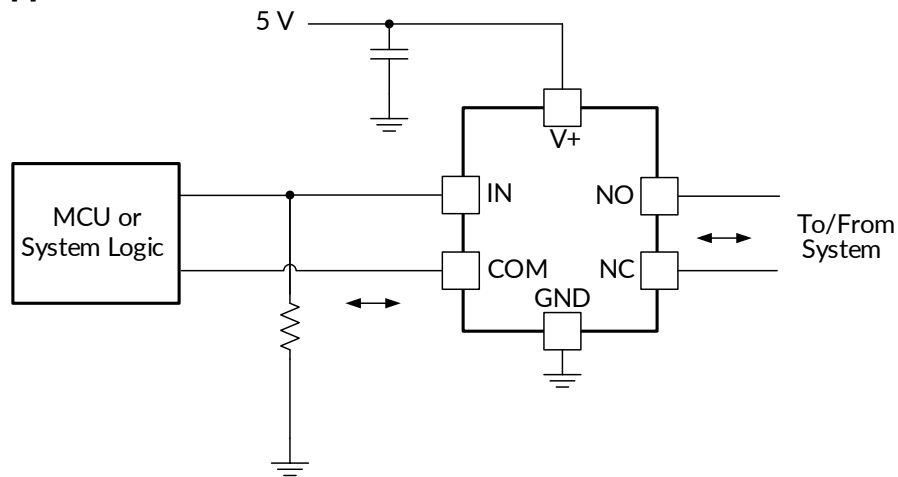
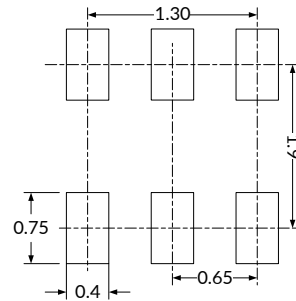
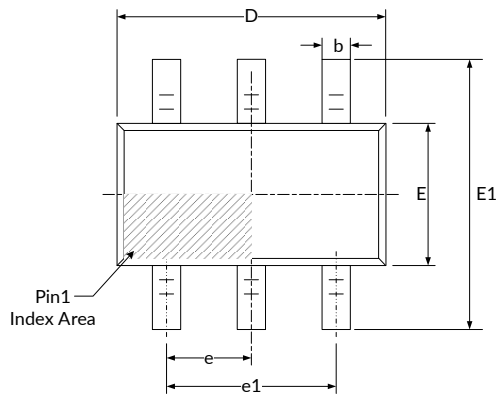


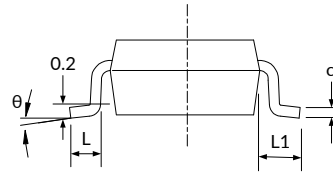
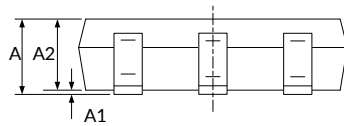
Figure 23. System Schematic for RS2057A

11 PACKAGE OUTLINE DIMENSIONS

SC70-6⁽³⁾



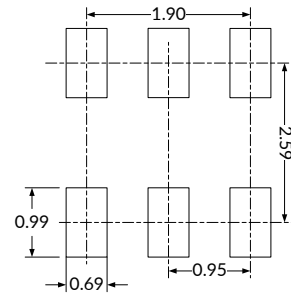
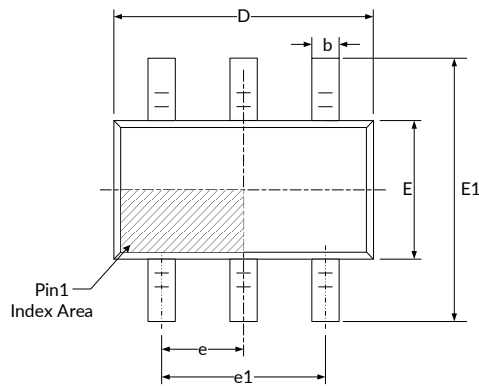
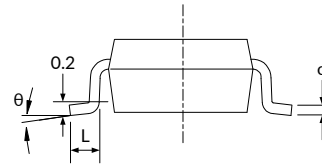
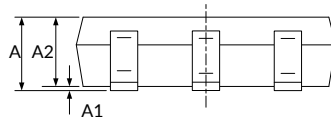
RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A ⁽¹⁾	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D ⁽¹⁾	2.000	2.200	0.079	0.087
E ⁽¹⁾	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650(BSC) ⁽²⁾		0.026(BSC) ⁽²⁾	
e1	1.300(BSC) ⁽²⁾		0.051(BSC) ⁽²⁾	
L	0.260	0.460	0.010	0.018
L1	0.525		0.021	
θ	0°	8°	0°	8°

NOTE:

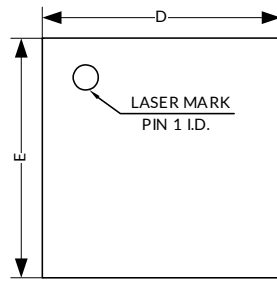
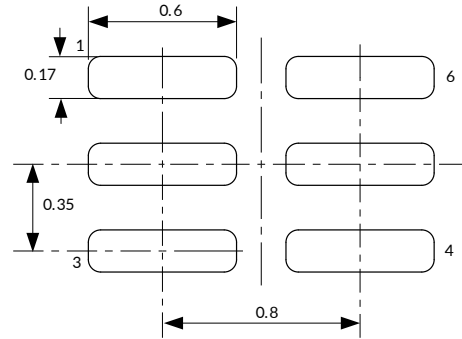
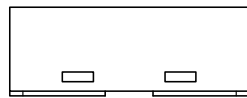
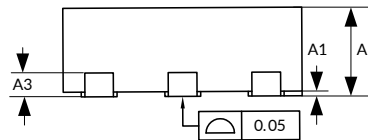
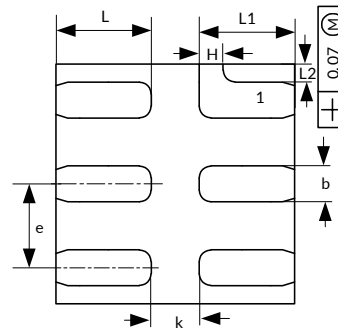
1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
3. This drawing is subject to change without notice.

SOT23-6⁽³⁾

RECOMMENDED LAND PATTERN (Unit: mm)


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A ⁽¹⁾	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D ⁽¹⁾	2.820	3.020	0.111	0.119
E ⁽¹⁾	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC) ⁽²⁾		0.037(BSC) ⁽²⁾	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

NOTE:

1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
3. This drawing is subject to change without notice.

XDFN1X1-6⁽³⁾

TOP VIEW

LAND PATTERN EXAMPLE

SIDE VIEW

SIDE VIEW

BOTTOM VIEW

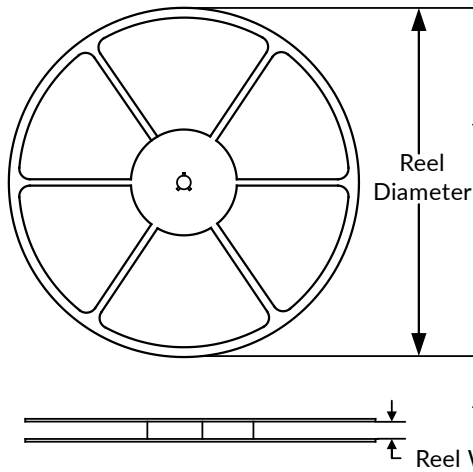
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A ⁽¹⁾	0.340	0.400	0.013	0.016
A1	0.000	0.050	0.000	0.002
A3	0.100 (REF) ⁽²⁾		0.004 (REF) ⁽²⁾	
b	0.100	0.200	0.004	0.008
D ⁽¹⁾	0.950	1.050	0.037	0.041
E ⁽¹⁾	0.950	1.050	0.037	0.041
e	0.300	0.400	0.012	0.016
H	0.100 (REF) ⁽²⁾		0.004 (REF) ⁽²⁾	
K	0.150		0.006	
L	0.350	0.450	0.014	0.018
L1	0.350	0.450	0.014	0.018
L2	0.075 (REF) ⁽²⁾		0.003 (REF) ⁽²⁾	

NOTE:

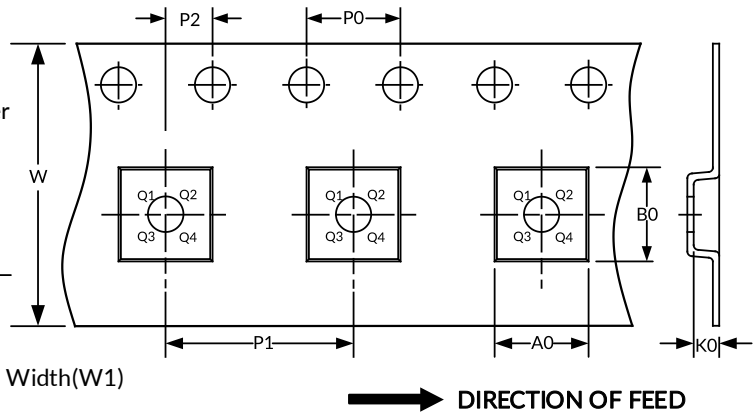
1. Plastic or metal protrusions of 0.075mm maximum per side are not included.
2. REF is the abbreviation for Reference.
3. This drawing is subject to change without notice.

12 TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width(mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SC70-6	7"	9.5	2.40	2.50	1.20	4.0	4.0	2.0	8.0	Q3
SOT23-6	7"	9.5	3.17	3.23	1.37	4.0	4.0	2.0	8.0	Q3
XDFN1X1-6	7"	9.5	1.14	1.17	0.56	4.0	4.0	2.0	8.0	Q3

NOTE:

1. All dimensions are nominal.
2. Plastic or metal protrusions of 0.15mm maximum per side are not included.

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